

MS23P25

P-Channel 20-V (D-S) MOSFET

Description

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

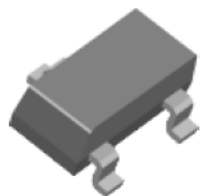
Features

- Low $r_{DS(on)}$ provides higher efficiency and extends battery life
- Low thermal impedance copper lead frame SOT-23 saves board space
- Fast switching speed
- High performance trench technology
- RoHS compliant package

Package type : SOT-23

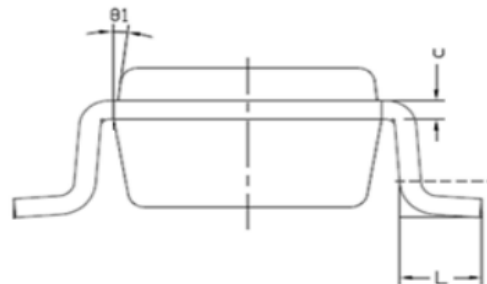
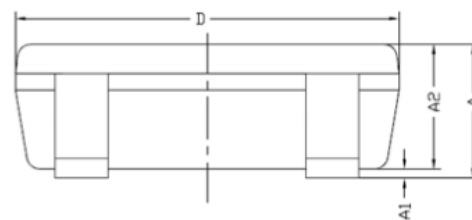
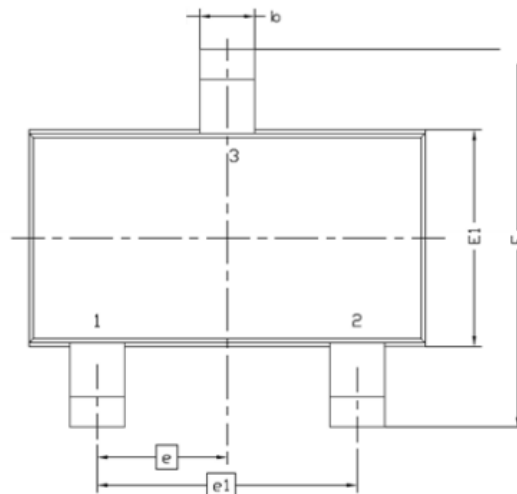
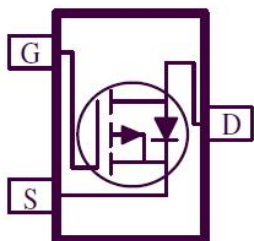
Packing & Order Information

3,000/Reel



**RoHS
COMPLIANT**

Graphic symbol



Symbol	MILLIMETERS	
	MIN	MAX
A	0.8	1.2
A1	0	0.1
A2	0.7	1.1
b	0.3	0.5
c	0.1	0.2
D	2.7	3.1
E	2.6	3
E1	1.4	1.8
e	0.95 BSC	
e1	1.9 BSC	
L	0.3	0.6
θ1	7° NOM	

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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{DS}	Drain-Source Voltage	-20	V
V _{GS}	Gate-Source Voltage	±12	V
I _D	Continuous Drain Current @ T _C =25°C	-3.6	A
I _{DM}	Pulsed Drain Current	-10	A
I _S	Continuous Source Current (Diode Conduction)	0.46	A
P _D	Power Dissipation (T _C =25°C)	1.25	W
T _J /T _{STG}	Operating Junction and Storage Temperature	-55 to +150	°C

NOTE: Repetitive rating; pulse width limited by maximum junction temperature.

Thermal characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
R _{θJA}	Maximum Junction-to-Ambient	100	°C/W
R _{θJC}	Maximum Junction-to-Case	106	

Static

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
V _{GS(th)}	Gate-Threshold Voltage	V _{DS} = V _{GS} , I _D = -250μA	-0.7			V
I _{GSS}	Gate-Body Leakage	V _{DS} = 0 V, V _{GS} = ±8 V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V V _{DS} = -16 V, V _{GS} = 0 V, T _J = 55°C			-1 -10	uA
I _{D(on)}	On-State Drain Current ^A	V _{DS} = -5 V, V _{GS} = -4.5 V	-10			A
r _{DS(on)}	Drain-Source On-Resistance ^A	V _{DS} = -4.5 V, I _D = -3.6 A V _{DS} = -2.5 V, I _D = -2.8 A V _{DS} = -1.8 V, I _D = -1.8 A			55 89 200	mΩ
g _{fs}	Forward Transconductance ^A	V _{GS} = -5 V, I _D = -3.6 A		12		S
V _{SD}	Diode Forward Voltage	I _S = -0.46 V, V _{GS} = 0 V		-0.60		V

Dynamic^b

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
Q _g	Total Gate Charge	V _{DS} = -5 V, I _D = -3.6 A, V _{GS} = -4.5 V		16.7		nC	
Q _{gs}	Gate-Source Charge			1.8		nC	
Q _{gd}	Gate-Drain Charge			1.9		nC	
t _{d(on)}	Turn-On Delay Time	V _{DD} = -10 V, R _G = 6 Ω, V _{GEN} = 4.5 V, I _L = -1 A		9		ns	
t _r	Rise Time			4		ns	
t _{d(off)}	Turn-Off Delay Time				25		ns
t _f	Fall Time				20		ns

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Notes:

- a. Pulse test: PW \leq 300us duty cycle \leq 2%.
- b. Guaranteed by design, not subject to production testing.
- c. Repetitive rating, pulse width limited by junction temperature.

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Typical Electrical Characteristics

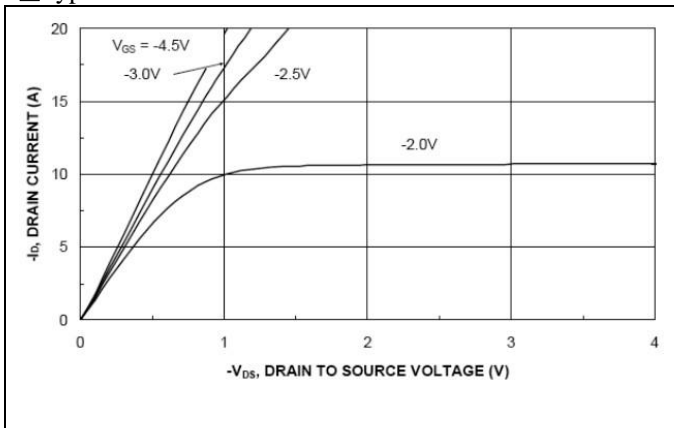


FIG.1-OUTPUT CHARACTERISTICS

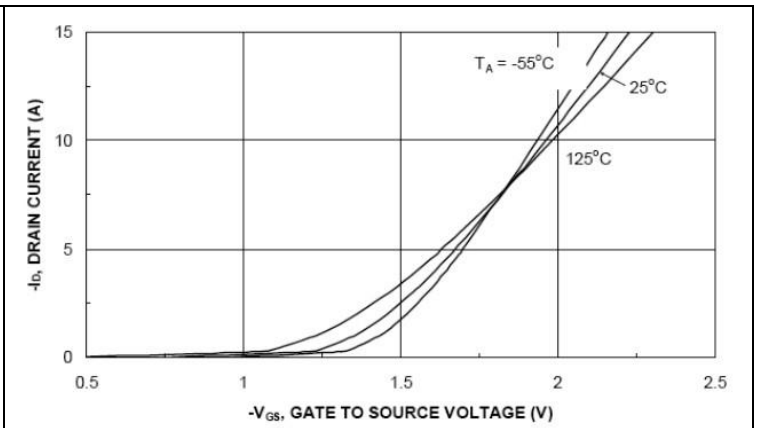


FIG.2-TRANSFER CHARACTERISTICS

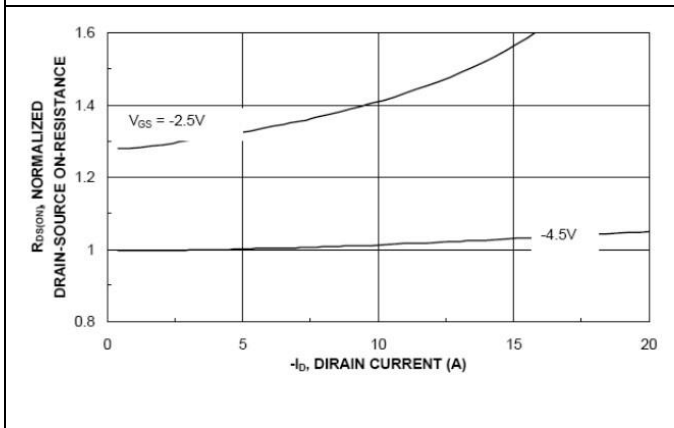


FIG.3-ON-RESISTANCE VS DRAIN CURRENT

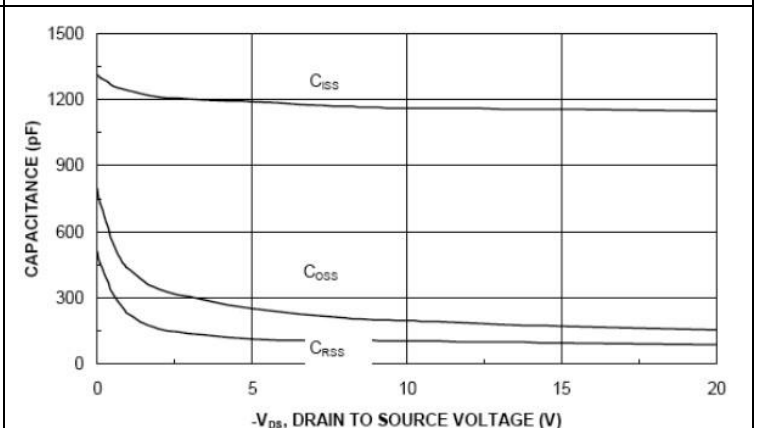


FIG.4-CAPACITANCE

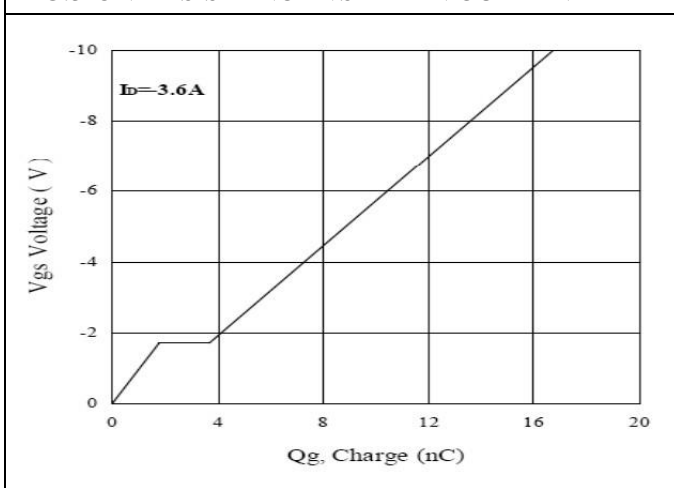


FIG.5-GATE CHARGE

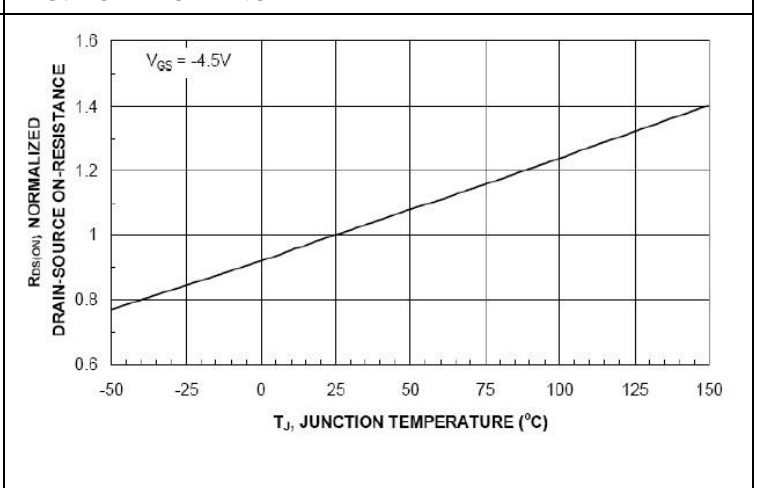


FIG.6-ON-RESISTANCE VS. JUNCTION TEMPERATURE

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